L Number	Hits	Search Text	DB	Time stamp
1	967	(fabry adj perot) or fabry-perot	EPO; JPO;	2003/01/29
_		,	IBM TDB	15:46
2	1016834	substrate or film or wafer	EPO; JPO;	2003/01/29
			IBM TDB	15:46
3	6	((fabry adj perot) or fabry-perot) and	EPO; JPO;	2003/01/29
	Ĭ	plasma	IBM TDB	15:46
4	6	I <b>↑</b>	EPO; JPO;	2003/01/29
•		adj perot) or fabry-perot) and plasma)	IBM TDB	15:46
5	93839	etch or etching	EPO; JPO;	2003/01/29
	, ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	000 02 000	IBM TDB	15:46
6	4	((substrate or film or wafer) and	EPO; JPO;	2003/01/29
· ·	1	(((fabry adj perot) or fabry-perot) and	IBM TDB	15:47
		plasma)) and (etch or etching)	12122	1
_	268	(356/519).CCLS.	USPAT;	2003/01/23
	200	(330/313/.0013.	US-PGPUB	16:09
_	5185	(fabry adj perot) or fabry-perot	USPAT;	2003/01/29
	] 3163	(lably adj peroc) of lably peroc	US-PGPUB	15:46
	158059	plasma	USPAT;	2003/01/23
-	130039	prasma	US-PGPUB	16:12
-	831115	substrate or film or wafer	USPAT;	2003/01/29
	831115	substrate of IIIM of Waler	US-PGPUB	15:46
	500	//E-bus add marety on fabrus marety and	USPAT;	2003/01/29
-	580	((fabry adj perot) or fabry-perot) and	US-PGPUB	15:46
	501	plasma	USPAT;	2003/01/29
-	501		US-PGPUB	15:46
		adj perot) or fabry-perot) and plasma)	•	2003/01/29
-	161974	etch or etching	USPAT;	15:46
			US-PGPUB	
-	335	((substrate or film or wafer) and	USPAT;	2003/01/29
		(((fabry adj perot) or fabry-perot) and	US-PGPUB	15:46
		plasma)) and (etch or etching)		0000 (01 (02
-	11	5225888.URPN.	USPAT	2003/01/23
	_			16:43
-	1	"5907820".PN.	USPAT	2003/01/23
				16:56
-	1	"5837094".PN.	USPAT	2003/01/23
				16:56
-	1	"5719495".PN.	USPAT	2003/01/23
				16:56
-	1	"5656902".PN.	USPAT	2003/01/23
			İ	16:57
-	1	"5654796".PN.	USPAT	2003/01/23
				16:57
-	138	356/454	USPAT;	2003/01/28
	-		US-PGPUB	11:40
-	11	5225888.URPN.	USPAT	2003/01/28
				11:49